

P/1596-99

## PATENIS 1103190995

R SHEET

To the Director of the U.S. Patent and Trademark Office: Please record the attached original document or copy thereof. 2. Name and Address of receiving party(ies): 1. Name of conveying party(ies): Koji HASEGAWA Dainippon Screen Mfg. Co., Ltd. Tenjinkita-cho 1-1, Teranouchi-agaru Akira MORITA Kenichiro ARAI 4-chome, Horikawa-dori, Kamigyo-ku Kyoto, Japan 602-8585 Type of Entity: Individual Type of Entity: Corporation-Japan Additional names(s) of conveying party(ies) attached? No Additional name(s) & address(es) attached? No 3. Nature of Conveyance: Assignment **Execution Date:** January 25, 2006 and January 26, 2006 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: January 25, 2006 and January 26, 2006 A. Application No.(s) B. Patent No.(s) Additional numbers attached? Name and address of party to whom 6. Total number of documents involved: 1 correspondence concerning document should be mailed: OSTROLENK, FABER, GERB & SOFFEN, LLP 7. Total fee (37 CFR 3.41): \$ 40.00 1180 Avenue of the Americas New York, New York 10036-8403 Enclosed as part of Check No. In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee due is not paid, the Patent and Trademark Office is authorized to charge the underpayment to Deposit Account No. 15-0700. DO NOT USE THIS SPACE 8. To the best of my knowledge and belief, the foregoing into mation is true and correct and any attached copy is a true copy of the original document. James A. Finder February 27, 2006 Name of Person Signing Signature Date Total number of pages including cover sheet, attachments, and document:

3/01/2006 KBE	TEMA1	0000004	ia i	13	62635
---------------	-------	---------	------	----	-------

04 FC:8021

40.00 00

00745493.1

PATENT APPLICATION ASSIGNMENT SOLE OR JOINT INVENTORS EXECUTED OUTSIDE U.S.A.

WHEREAS, We, Koji HASEGAWA, Akira MORITA and Kenichiro ARAI as assignors, have invented certain improvements in WAFER TREATING APPARATUS for which an application for United States Letters Patent has been executed by me (us) of even date herewith; and

WHEREAS, DAINIPPON SCREEN MFG. Co., Ltd. of 1-1 Tenjinkitamachi, Teranouchi-agaru 4-chome, Horikawa-dori, Kamikyo-ku, Kyoto, Japan as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I, as assignor, hereby sell, assign and set over to said assignee the entire right, title and interest for the United States in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute, reissue or reexamination applications and patents applied for or granted therefor in the United States and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting there from to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States, the expenses incident to said applications to be borne and paid by said assignee.

Date: (25 (200 b	Koji Hasegawa
	Koji HASEGAWA
Date: 1/26/2006	Akira MORITA
	Akira MORITA
Date: 1/26/2606	Kenichiro Ami
	Kenichiro ARAI
Date:	
Date:	

LEGALIZATION RECOMMENDED

PATENT REEL: 017623 FRAME: 0797

RECORDED: 02/27/2006